8-bit μ P compatible A-D converter

ADVANCE PRODUCT INFORMATION

ZN439 Series

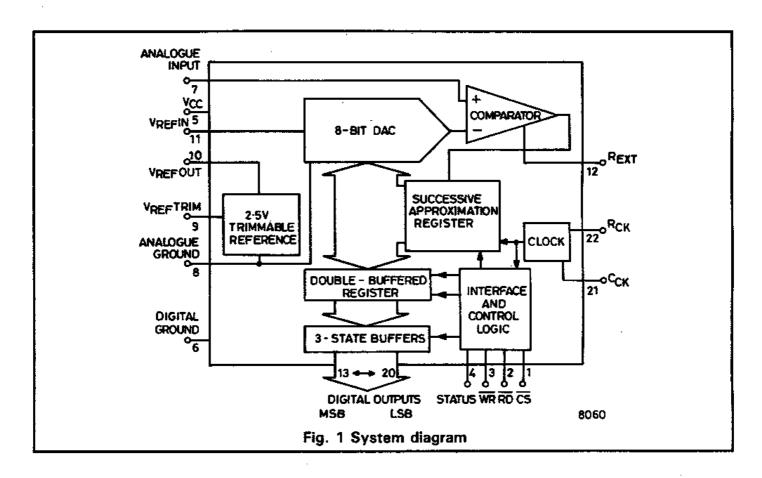
FEATURES

- Choice of linearity: ¼LSB-ZN439-9, ½LSB-ZN439-8, 1LSB-ZN439-7
- 5µs conversion time
- μP, TTL and CMOS compatible
- On-chip clock
- Trimmable bandgap reference
- Versatile microprocessor interfacing with double buffered output latch
- Equally suitable for stand alone applications
- ROM type operation
- Commercial or military temperature ranges
- 22 lead DIL package

DESCRIPTION

The ZN439 is an 8-bit successive approximation A-D converter designed to be easily interfaced to microprocessors. All active circuitry is contained on-chip including clock generator, trimmable 2.5V bandgap reference, control logic and double buffered latches with three-state outputs.

These features give extra flexibility in use, with just three inputs to control all ADC operations and double buffered output latches which will allow data to be read at any time irrespective of the status of the converter.



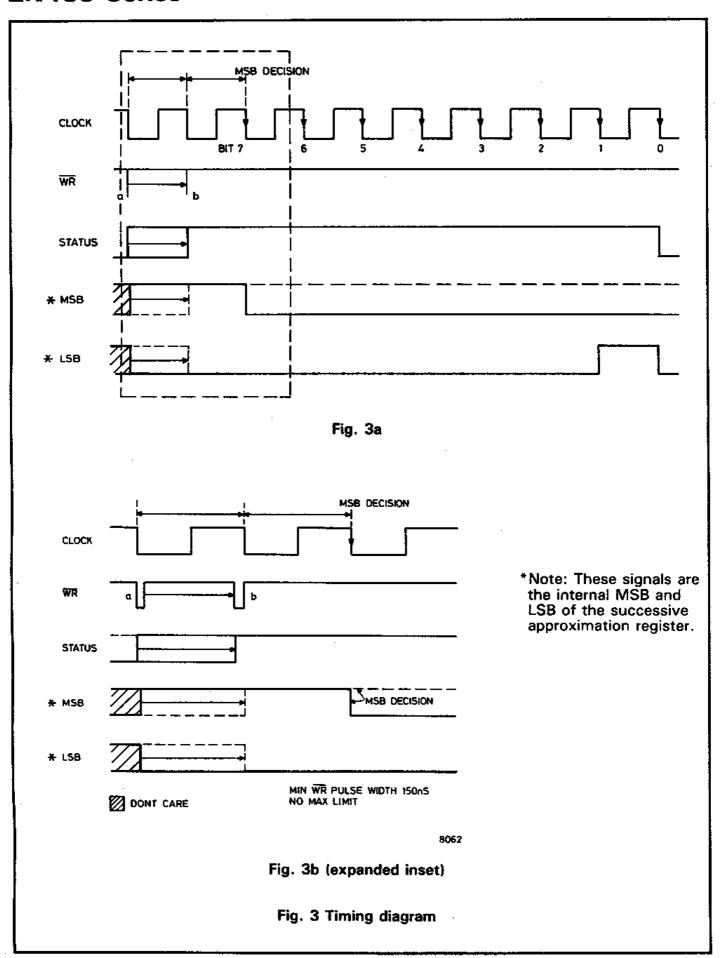
ABSOLUTE MAXIMUM RATINGS

ELECTRICAL CHARACTERISTICS (at $V_{CC} = 5V$, $T_{amb} = 25$ °C and $f_{CLK} = 1.6 MHz$ unless otherwise specified).

| Parameter | T _{amb} = + 25°C | | Over specified Temp. range | | Units | Conditions | |
|--|--------------------------------|--|--|------------------|------------------------------|---|--|
| | Min. | Тур. | Max. | Min. | Max. | | |
| ZN439-9 Linearity error Differential linearity error ZN439-8 | – – · | _ _ | ±0.25 ±0.5 | _ _ | ±0.25 ±0.5 | LSB LSB | |
| Linearity error Differential linearity error ZN439-7 | | _ _ | ±0.5 ±0.75 | <u>-</u> | ±0.5 ±0.75 | LSB LSB | |
| Linearity error Differential linearity error | I | – | ± 1 ± 1 | <u>-</u> | ± 1 ± 1 | LSB LSB | |
| ALL TYPES Zero transition (00000000 → 00000001) Full-scale transition (111111110 → 11111111) | 1 1 1 | 7 7 2.550 2.550 | | _ _ _ _ | _ _ _ | mV mV V | Moulded "E" Ceramic "J" Moulded "E" Ceramic "J" |
| Linearity temperature coefficient Differential linearity temperature coefficient Gain temperature coefficient Offset temperature coefficient | | | ±3 typ. ±6 typ. ±10 typ ±7 typ. | | | ppm/°C ppm/°C ppm/°C ppm/°C | Ext. Ref. |
| Resolution Conversion time Supply rejection Supply voltage Supply current Power consumption Reference input range Ladder output impedance | 8 5 - 4.5 - 1.5 | - 0.2 5.0 30 150 - 2.7 | - 5.5 45 225 3.0 | 4.5 | - - 5.5 - - - | Bits μs %/V V mA mW V kΩ | Outputs in high impedance state |
| COMPARATOR Input current | _ | 1.0 | | _ | | μΑ | V _{in} = + 3V R _{ext} = 82K |
| Input resistance Tail current | - 25 | 100 | _ 150 | - 25 | _ 150 | kΩ μA | R _{ext} = 82K V - = -5V |
| Negative supply Input voltage | -3 -0.5 | -5 - | -30 +3.5 | -3 -0.5 | -30 +3.5 | V V | |

ELECTRICAL CHARACTERISTICS (Cont.)

| 1 | | | | | T | |
|--------------------------|-------|---|-----------------------------------|------------------------------|-----------------------------------|--|
| T _{amb} = +25°C | | Over specified Temp. range | | Units | Conditions | |
| Min. | Тур. | Max. | Min. | Max. | | |
| | .=. | | | | | |
| - | 2.588 | - | <u></u> | _ | V | PIN 9 NC R _{REF} = 1.6K |
| - | _ | +3 | _ | _ | % | $C_{REF} = 0.47 \mu F$ |
| | 0.75 | _ | | _ | 1 - | |
| 0.25 | _ | 5.2 | 0.25 | 5.2 | 1 | |
| - | - | ı | | 1 | | R _{TRIM} = 10K |
| — | 70 | _ | _ | | f ' | |
| | ., | ·- | | | | |
| _ : | 1.6 | - | - | - | MHz | $R_{ck} = 1.5K\Omega$ $C_{ck} = 100pF$ (See Fig. 13) |
| | -0.1 | _ | _ |] _ | %/°C | (000 1 ig. 10) |
| 100 | - | _ | _ | _ | pF | |
| 1.0 | - 1 | | | | kΩ | |
| 2 | | _ | 2 | _ | MHz | |
| 250 | - | _ [| _ | _ | ns | |
| 3.5 | - | - | 3.5 | _ | ٧ | |
| - | | 0.8 | _ | 0.8 | ٧ | |
| | 1 | - | _ | _ | μΑ | V _{CC} = 5.5V V _{IN} = 4V |
| - | 10 | ÷ | - | | ·n A | V _{CC} = 5.5V V _{IN} = 0.8V |
| _ | 3.5 | - | - | ! - | %/V | Int. clock Freq. |
| | | | | | | |
| 2 | _ | _ | 2 | _ | v | |
| _ | - | 0.8 | _ | 0.8 | v | |
| | 40 | - [| - | · – | μΑ | $V_{CC} = +5.5V$ $V_{IN} = +5.5V$ |
| - | 20 | - | _ | . – | μΑ | $V_{CC} = +5.5V$ $V_{IN} = +2.4V$ |
| _ | - 50 | | - | - | μΑ | $V_{CC} = +5.5V$ $V_{IN} = +0.4V$ |
| | | | | | | |
| 2 | - | - | 2 | _ | V | |
| - | - | 0.8 | | 0.8 | v | · |
| | 220 | - | - | - | μΑ | $V_{CC} = +5.5V$ $V_{IN} = +5.5V$ |
| | Min. | Min. Typ. - 2.588 - 0.75 0.25 - 70 - 1.6 - 0.1 100 - 1.0 2 - 2 250 3.5 - 1 - 10 - 3.5 2 - 40 - 20 - 50 | Min. Typ. Max. - 2.588 - - 0.75 | Min. Typ. Max. Min. - 2.588 | Min. Typ. Max. Min. Max. - 2.588 | Min. Typ. Max. Min. Max. Max. |



CONVERSION TIMING

The ZN439 will accept a low going convert (WR) pulse, which can be completely asynchronous with respect to the clock, and will produce valid data between 8 and up to 9 clock pulses later depending on the relative timing of the clock and convert signals. Timing diagrams for a conversion are shown in Fig. 3.

The ZN439 is first selected by taking \overline{CS} (chip select) low. The converter is cleared by a low going convert (WR) pulse, which sets the most significant bit and the status while resetting all other bits. Holding the WR input low will not inhibit the operation of the device.

The convert (WR) pulse can be as short as 150ns; however the MSB must be allowed to settle for at least 625ns before the MSB decision is made. To ensure that this criterion is met even with short write pulses the converter waits for a falling clock edge before commencing with the conversion. This ensures that the MSB is allowed to settle for at least a full clock period or 625ns at maximum clock frequency. If the WR input is pulsed low at any time the conversion will restart. The input signals can be locked out during a conversion by removing the CS signal. This will isolate the converter from the external signals around it.

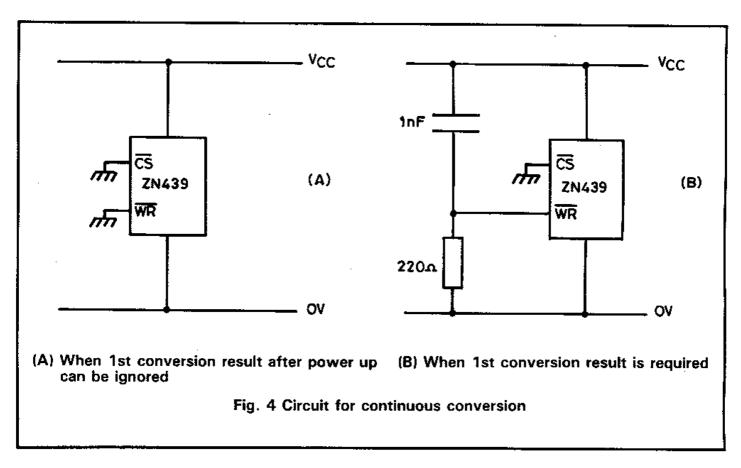
The status output goes low at the end of a conversion indicating that new data is now

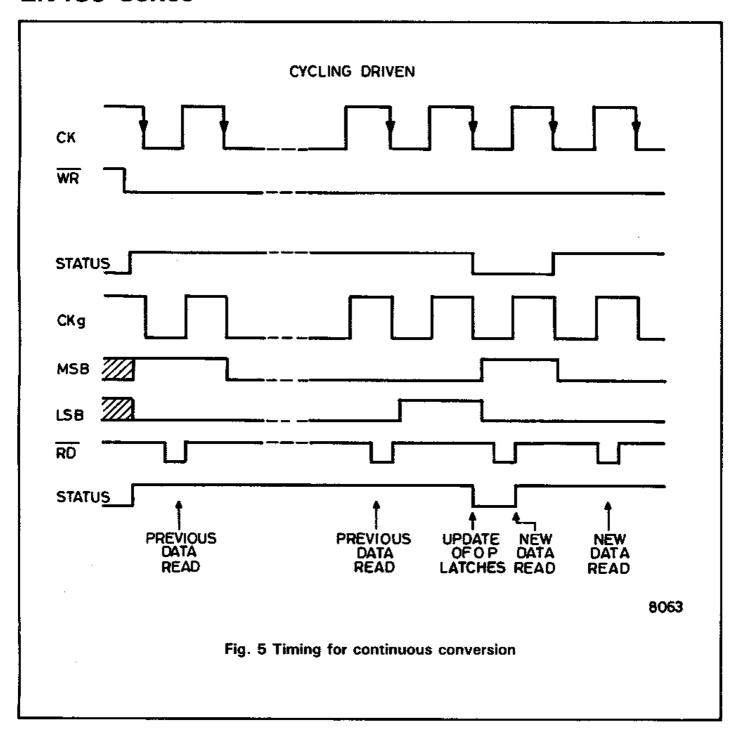
available. Internal logic monitors the WR input and if at the end of a conversion the WR input is high the clock signal will be locked out of the converter leaving it set up (i.e. the code 1000000 will appear on the input to the DAC) and waiting for its next convert (WR) pulse. If the WR input is low the clock signal will not be inhibited allowing the converter to procede with another conversion. The double buffering on the three-state data outputs gives extra flexibility allowing the RD input to operate completely asynchronously with respect to the status and always produce valid data. Note that the RD input cannot be tied low as this will prevent the converter from updating at the end of a conversion.

CONTINUOUS CONVERSION

The ZN439 can be made to cycle by simply tying the CS and WR inputs low. If, after a power up, the result of the first conversion can be ignored then no further external components are needed to operate the device in this mode. If however, the result of the first conversion is required an external R and C are needed to ensure a high to low transistion on the WR pin which will ensure correct operation immediately.

A timing diagram for the continuous conversion mode is shown in Fig. 5 (overleaf).



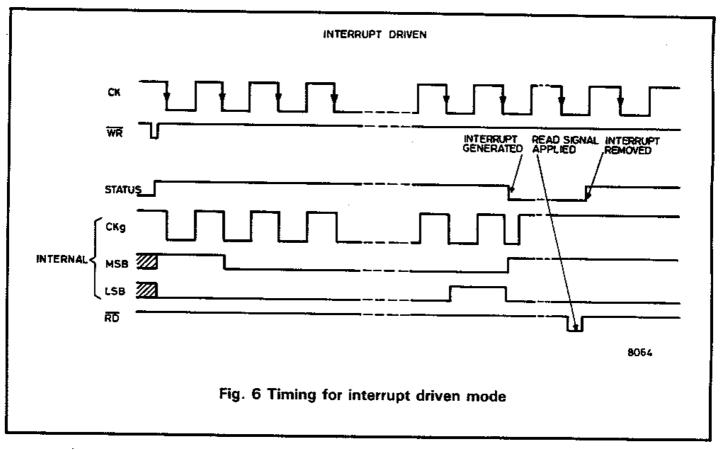


INTERRUPT DRIVEN

The ZN439 can also be used in an interrupt driven mode by using the status output. A WR pulse initiates a conversion sending the status high. The high to low transition of the STATUS output, indicating the end of a conversion, can be used as an interrupt signal by the microprocessor i.e. informing the microprocessor that a conversion has been completed. On receiving the interrupt the microprocessor

sends out an \overline{RD} pulse to take in the new data. On the rising edge of the \overline{RD} pulse data is latched into the microprocessor and internal control logic forces the status output high hence removing the interrupt signal.

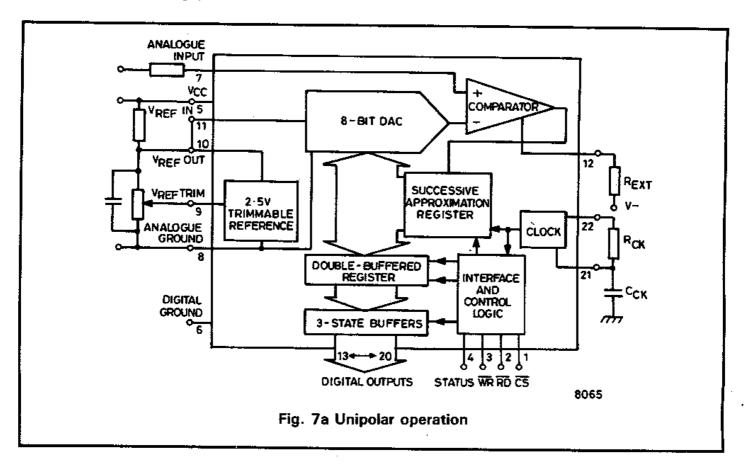
A timing diagram for the interrupt driven mode is shown in Fig. 6.



'STAND ALONE' OPERATION

The ZN439 is equally suitable for stand alone applications containing an on-chip clock and a 2.5V trimmable bandgap reference.

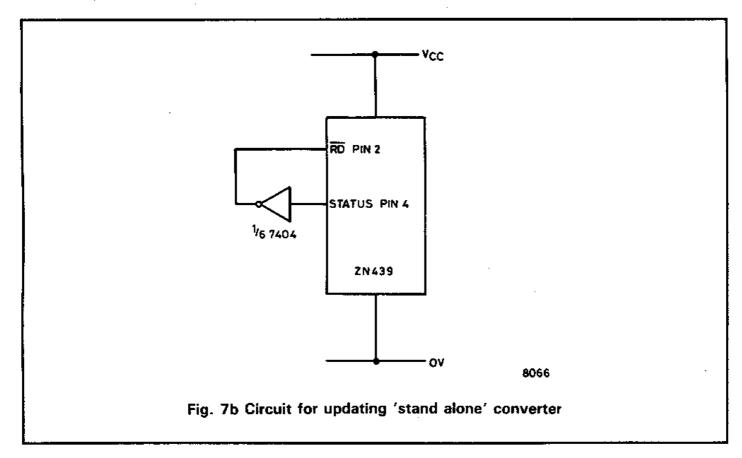
A typical circuit for unipolar operation is shown in Fig. 7a.

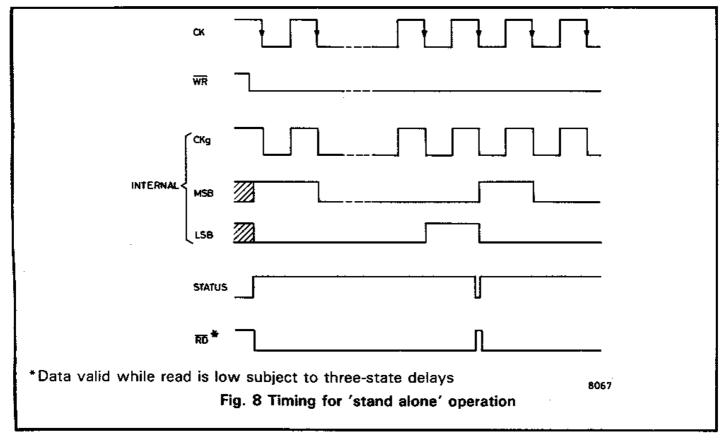


By tying the WR and CS inputs low the device can be made to cycle. Also if the status output is connected via an inverter to the RD input the device can be updated at the end of each conversion and the output buffers enabled

without the need for extra external control signals.

A timing diagram for stand alone operation is shown in Fig. 8.



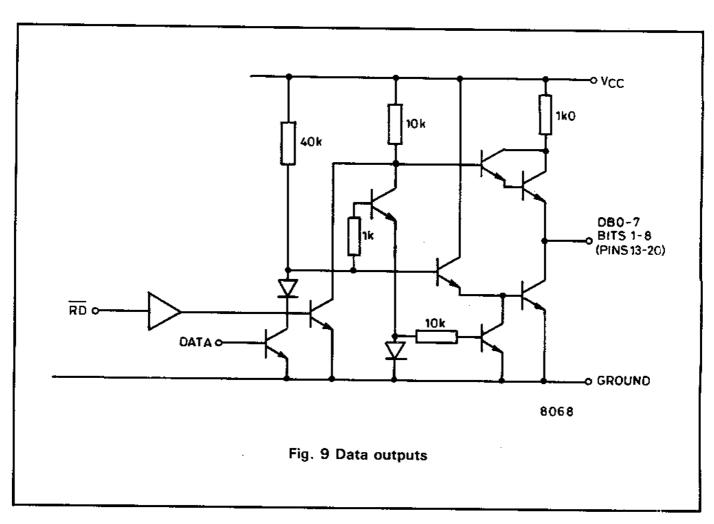


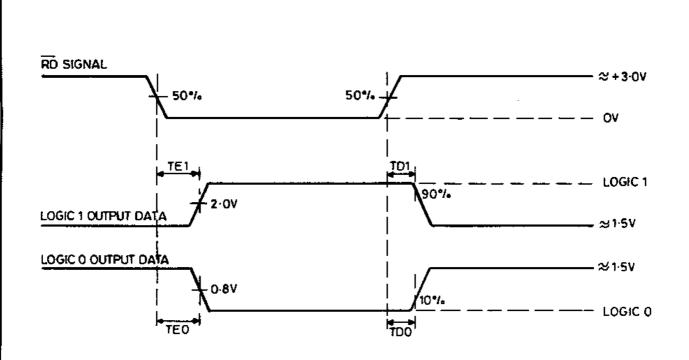
DATA OUTPUTS

The data outputs are provided with three-state buffers to allow connection to a common data bus. An equivalent circuit is shown in Fig. 9. Whilst the RD input is high both output transistors are off and the device presents only a high impedance load to the bus. When RD is low the data outputs will assume the logic states present on the outputs of the double buffered register.

A test circuit and timing diagram for the output enable/disable delays are given in Fig. 10 (overleaf).

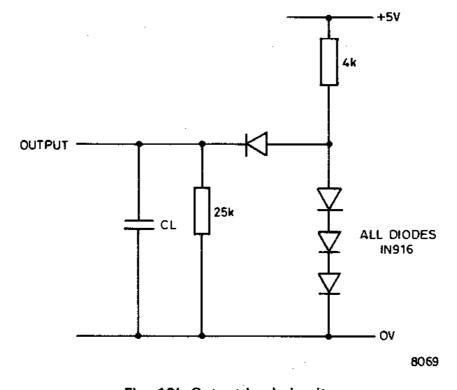
The status output utilises the same active pullup as the data outputs for CMOS/TTL compatibility.

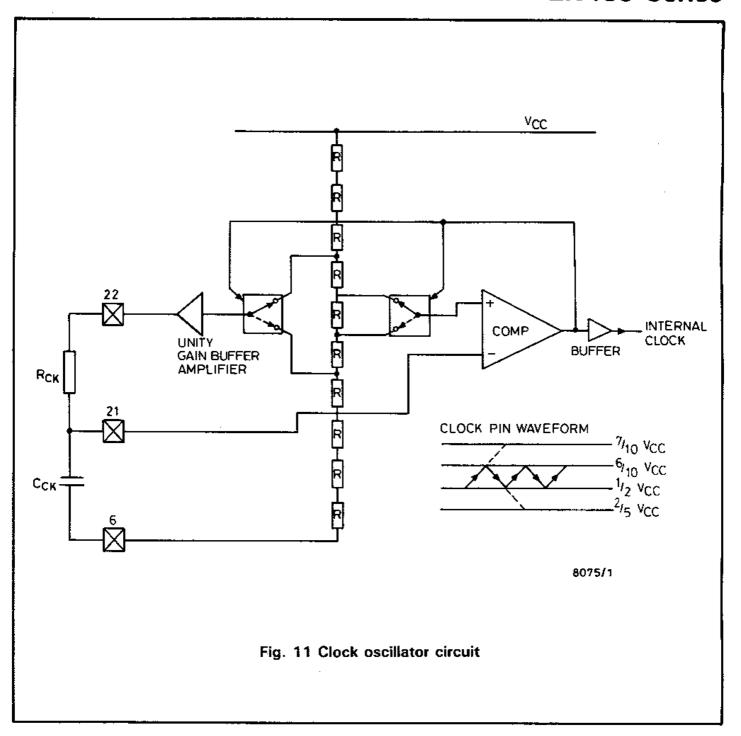




TE = RD ENABLE DELAY TIME (CL = 50pf)
TO = RD DISABLE DELAY TIME (CL = 50pf)

Fig. 10a Output enable/disable delays





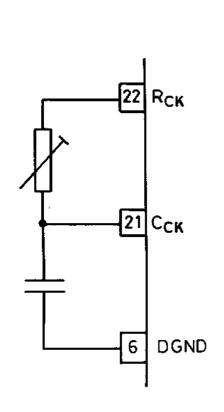
ON-CHIP CLOCK

The ZN439 on-chip clock oscillator operates with only two external components; a resistor connected between pin 21 and pin 22 and a capacitor between pin 21 and pin 6. The clock oscillator circuit and the external component connections are shown in Fig. 11.

The oscillator frequency may be varied with the

aid of a potentiometer or variable capacitor as shown in Fig. 12a and Fig. 12b. Alternatively it is possible to overdrive the oscillator input with an external clock signal from a TTL or GMOS gate as shown in Fig. 12c.

A graph of oscillator frequency against capacitor and resistor values is given in Fig. 13.



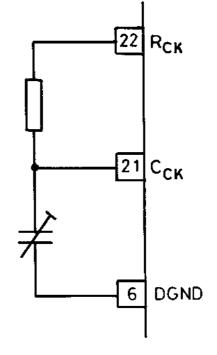


Fig. 12a Fixed capacitor
+ fixed/variable resistor

Fig. 12b Fixed resistor
+ fixed/variable capacitor

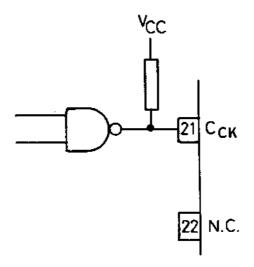
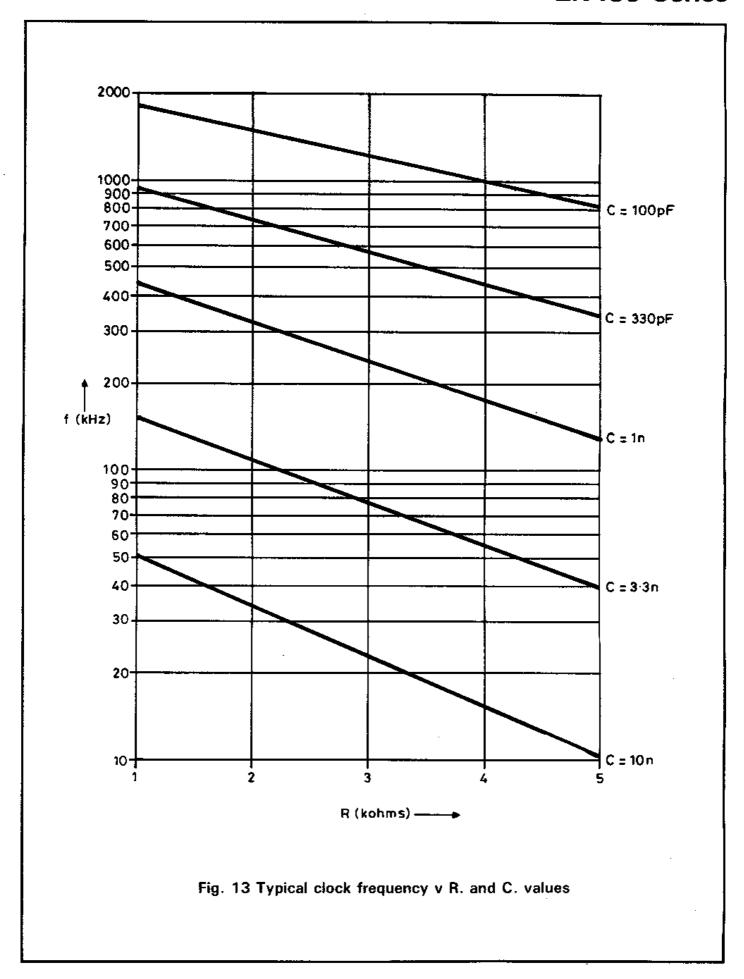


Fig. 12c External TTL or CMOS drive

Fig. 12 Clock circuit external components



ANALOGUE CIRCUITS

REFERENCE

(a) Internal reference

The internal reference is an active bandgap circuit which is equivalent to a 2.5 Zener diode with a very low slope impedance (Fig. 14). A resistor (R_{REF}) should be connected between V_{CC} and $V_{REF\ OUT}$, and a decoupling capacitor, $C_{REF}\ (0.47\mu F)$, is required between $V_{REF\ OUT}$ and AGND. For internal reference operation $V_{REF\ OUT}$ is connected to $V_{REF\ IN}$.

A suitable current to drive one ZN439 is nominally 1.5mA and will be supplied by an R_{REF} of 1K6 [(5-2.56)/1K6=1.5mA].

If the reference is required to drive more than one ZN439 then the reference current can be increased e.g. an $R_{REF}\!=\!470\Omega$ will supply a nominal reference current of (5-2.56)/0.47=5.2mA and this may be used to drive up to four ZN439's from just one internal reference. This useful feature saves power and gives excellent gain tracking between the converters.

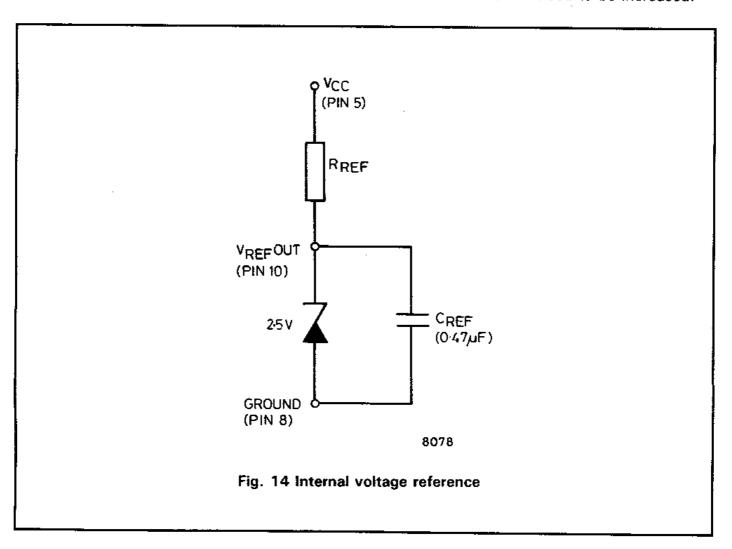
Alternatively with $R_{REF} = 680\Omega$, the internal reference can be used as the reference voltage for other external circuits and can source or sink up to 1.5mA.

(b) External reference

If required an external reference in the range +1.5 to +3.0V may be connected to $V_{REF\ IN}$. The slope resistance of such a reference source should be less than $\frac{2.5\Omega}{n}$, where n is the number of converters supplied.

RATIOMETRIC OPERATION

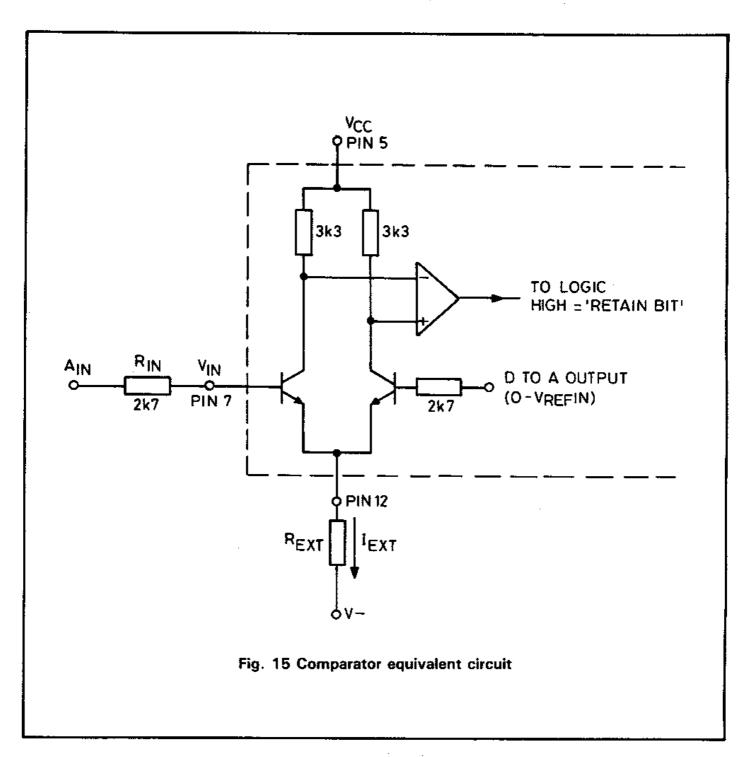
If the output from a transducer varies with its supply then an external reference for the ZN439 should be derived from the same supply. The external reference can vary from +1.5 to +3.0V. The ZN439 will operate if $V_{REF\,IN}$ is less than +1.5V but reduced overdrive to the comparator will increase its delay and so the conversion time will need to be increased.

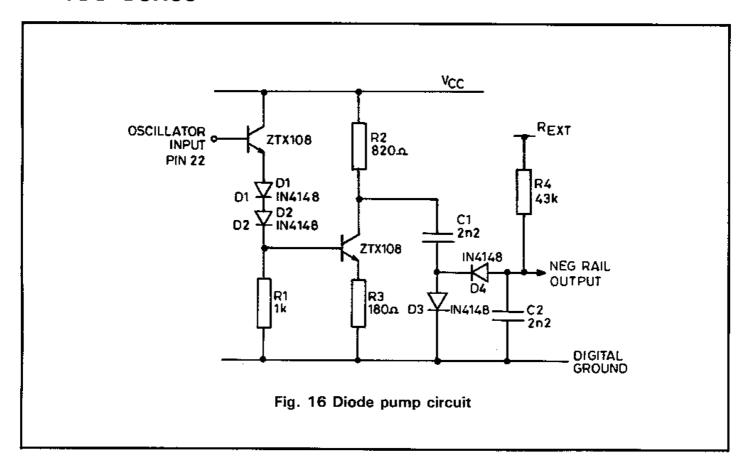


COMPARATOR

The ZN439 contains a fast comparator, the equivalent input circuit of which is shown in Fig. 15. A negative supply voltage is required to supply the tail current of the comparator.

However as this is only 25 to $150\mu\text{A}$ and need not be well stablised it can be supplied by a simple diode pump circuit driven from the R_{CK} pin (pin 22).





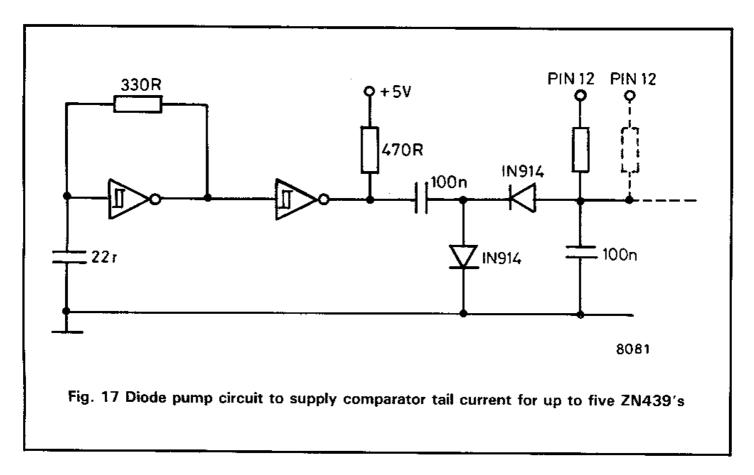


Table 1

A suitable circuit is shown in Fig. 16. This circuit can be used in any converter operation mode. The diode pump circuit shown in Fig. 16 is driven by the on-chip clock (pin 22) and applies a voltage of about — 3V to R4, thus providing the tail current for the comparator.

Where several ZN439's are used in a system the self-oscillating diode pump circuit of Fig. 17 is recommended. Alternatively, if a negative supply is available in the system then this may be utilised. A list of suitable resistors for different supply voltages is given in Table 1.

| V_ (volts) | R _{EXT} (kΩ) |
|------------|-----------------------|
| 3 | 47 |
| 5 | 82 |
| 10 | 150 |
| 12 | 180 |
| 15 | 220 |
| 20 | 330 |
| 25 | 390 |
| 30 | 470 |

D-A CONVERTER

The converter is of the voltage switching type and uses an R-2R ladder network as shown in Fig. 18. Each element is connected to either OV or $V_{\text{REF}\ IN}$ by transistor voltage switches specially designed for low offset voltage (1mV).

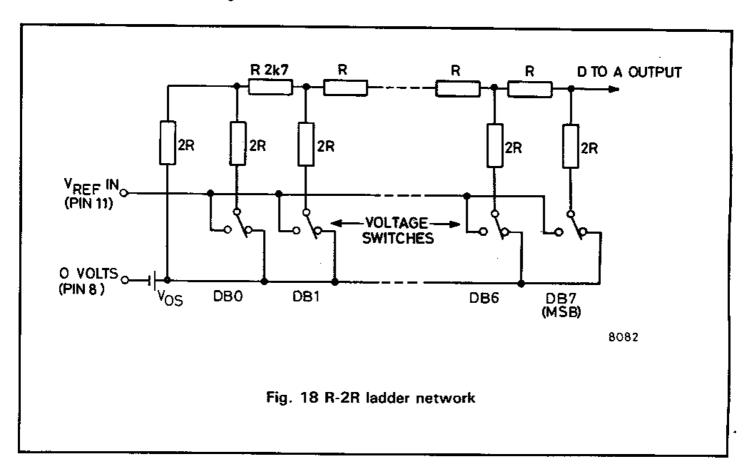
A binary weighted voltage is produced at the output of the R-2R ladder:

D-A output =
$$\frac{n}{256}$$
 (V_{REF IN} -V_{OS}) + V_{OS}

where n is the digital input to the D-A from the successive approximation register.

V_{OS} is a small offset voltage that is produced by the device supply current flowing in the package lead resistance. This offset will normally by removed by the setting up procedure and since the offset temperature coefficient is low (7ppm/°C) the effect on accuracy will be negligible.

The D-A output range can be considered to be $0 - V_{REF IN}$ through an output resistance R(2k7).

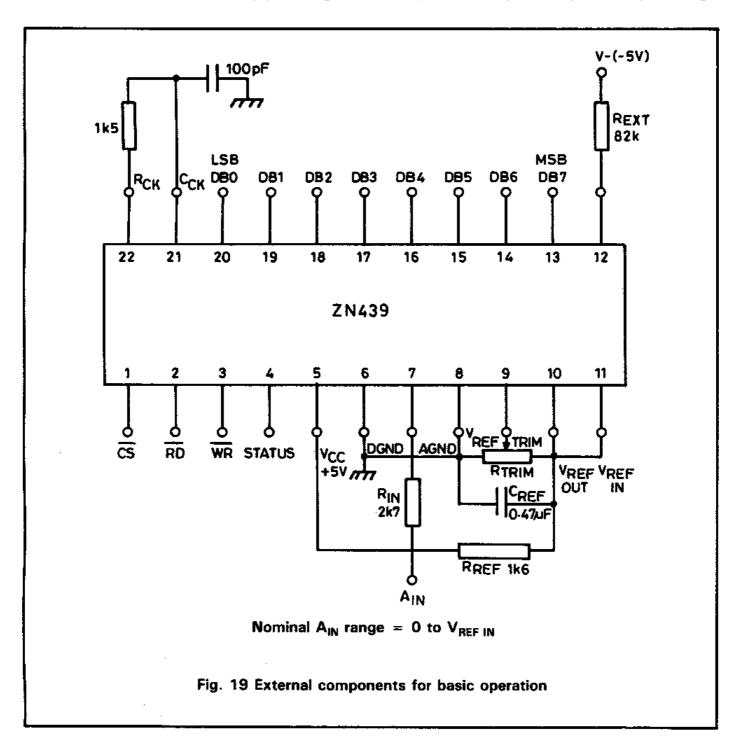


ANALOGUE INPUT RANGES

The basic connection of the ZN439 shown in Fig. 19 has an analogue input range 0 to $V_{REF\,IN}$ which, in some applications, may be made available from previous signal conditioning/scaling circuits. Input voltage ranges greater than this are accommodated by providing an

attenuator on the comparator input, whilst for smaller input ranges the signal must be amplified to a suitable level.

Bipolar input ranges are accommodated by offsetting the analogue input ranges so that the comparator always sees a positive input voltage.



UNIPOLAR OPERATION

The general connection for unipolar operation is shown in Fig. 20.

The values of R_1 and R_2 are chosen so that $V_{IN} = V_{REF\ IN}$ when the analogue input (A_{IN}) is at full-scale.

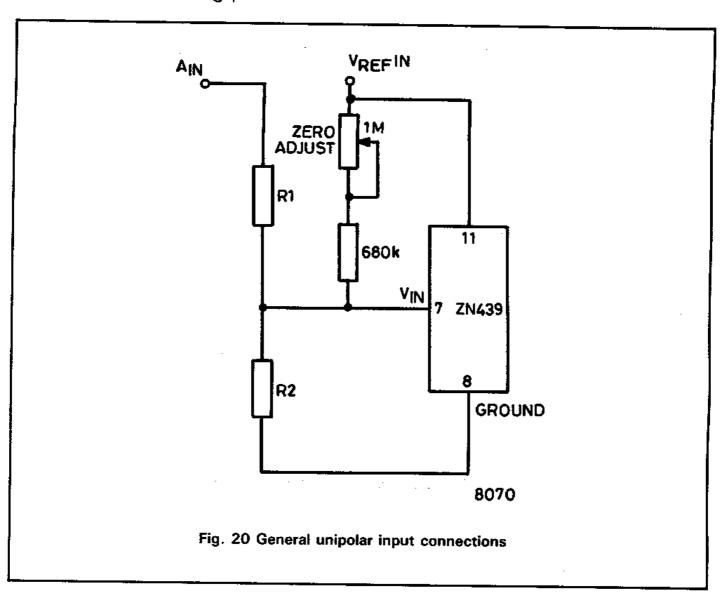
The resulting full-scale range is given by: $A_{IN}FS = \left(1 + \frac{R_1}{R_2}\right)$, $V_{REF\ IN} = G.V_{REF\ IN}$.

To match the ladder resistance $R_1/R_2\ (R_{IN})=2.7k.$

The required nominal values of R_1 and R_2 are given by $R_1 = 2.7Gk$, $R_2 = \underbrace{2.7G}_{G-1}k$

Using these relationships a table of nominal values of R_1 and R_2 can be constructed for $V_{\text{REF IN}} = 2.5 \text{V}$.

| Input range | G | R ₁ | R ₂ |
|-------------|---|----------------|----------------|
| + 5V | 2 | 5.4k | 5.4k |
| + 10V | 4 | 10.8k | 3.6k |



GAIN ADJUSTMENT

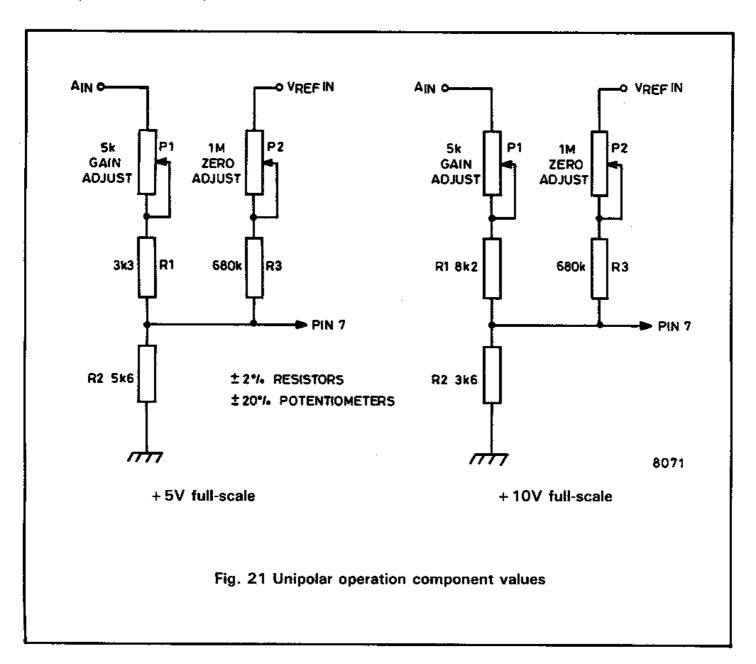
Due to tolerances in R_1 and R_2 , tolerances in V_{REF} and the gain (full-scale) error of the DAC, some adjustment should be incorporated into R_1 to calibrate the full-scale of the converter. When used with the internal reference and 2% resistors a preset capable of adjusting R_1 by at least $\pm\,5\%$ of its nominal value is suggested.

ZERO ADJUSTMENT

Zero adjustment must be provided to set the zero

transition to the value of $+\frac{1}{2}$ LSB. This is achieved by applying an adjustable positive offset to tie the comparator input via P2 and R₃. The values shown are suitable for all input ranges greater than $1\frac{1}{2}$ times $V_{REF\ IN}$.

Practical circuits values for +5 and +10V input ranges are given in Fig. 21 which incorporates both zero and gain adjustments.



UNIPOLAR ADJUSTMENT PROCEDURE

 (i) Apply continuous WR pulses at intervals long enough to allow a complete conversion or hold WR low and monitor the digital outputs.

OFFSET SETTING

(ii) Apply ½ LSB to A_{IN} and adjust zero until DBO (LSB) just flickers between 0 and 1 with

all other bits at O.

i.e. for transition 00000000 to 00000001.

GAIN SETTING

(iii) Apply full-scale minus 1.½LSB to A_{IN} and adjust gain until DBO (LSB) just flickers between 0 and 1 with all other bits at 1.

i.e. for transition 11111111 to 11111110.

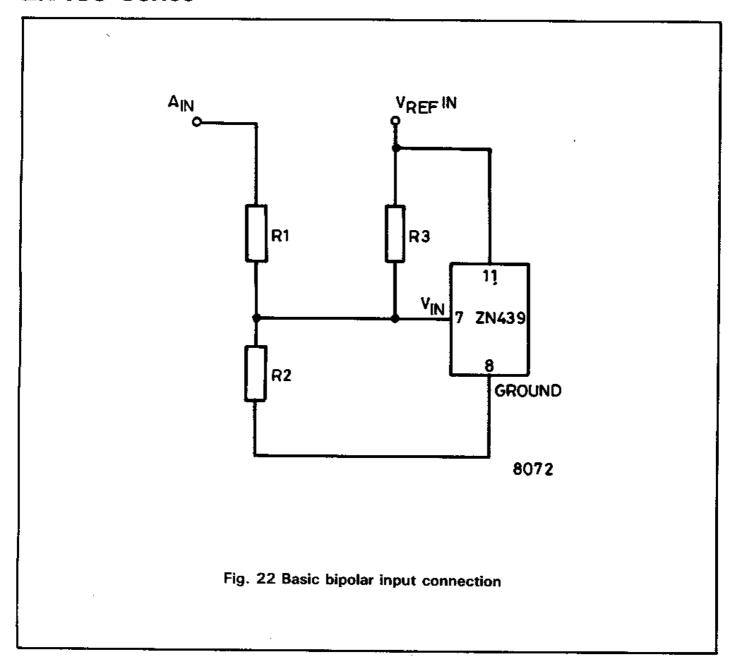
UNIPOLAR SETTING-UP POINTS

| Input range, +FS | ½LSB | FS - 1½LSB |
|------------------|--------|------------|
| + 5V | 9.8mV | 4.9707V |
| + 10V | 19.5mV | 9.9414V |

$$1LSB = \frac{FS}{256}$$

UNIPOLAR LOGIC CODING

| Analogue input (A _{IN}) | Output code |
|--|--|
| (Nominal code centre value) | (Binary) |
| FS - 1LSB FS - 2LSB %FS % FS + 1LSB %FS 1LSB 1LSB 0 | 1111111 11111110 11000000 10000001 1000000 |



BIPOLAR OPERATION

For bipolar operation the input to the ZN439 is offset by half full-scale by connecting a resistor R_3 between $V_{\rm REF\ IN}$ and $V_{\rm IN}$ (Fig. 22).

When $A_{\text{IN}} = -FS$, V_{IN} needs to be equal to zero.

When $A_{IN} = +FS$, V_{IN} needs to be equal to $V_{REF\ IN}$.

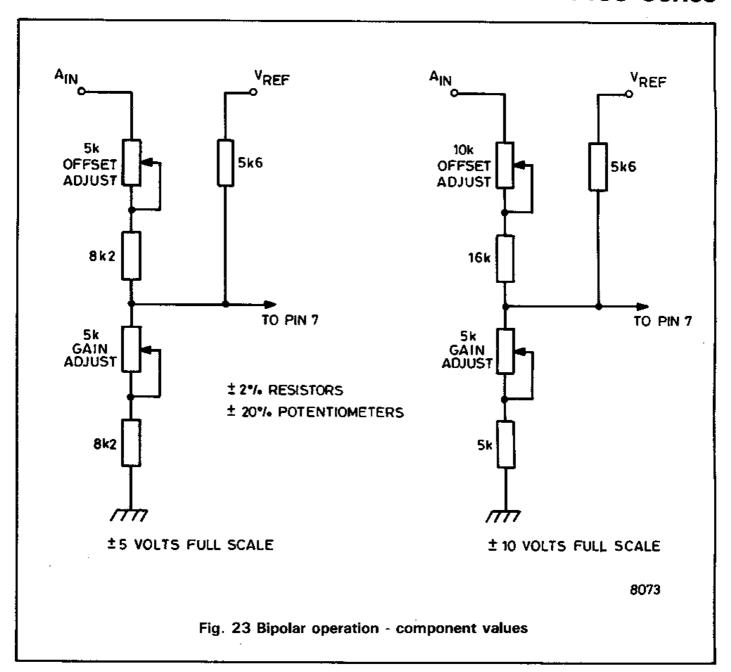
If the full-scale range is $\pm G$, $V_{REF\ iN}$ then $R_1 = (G-1)$, R_2 and $R_1 = G$, R_3 fulfil the required conditions.

To match the ladder resistance, $R_1/R_2/R_3$ (= R_{IN}) = 2.7k.

Thus the nominal values of R_1 , R_2 , R_3 are given by $R_1 = 5.4$ Gk, $R_2 = 5.4$ G/(G - 1)k, $R_3 = 5.4$ k.

A bipolar range of $\pm V_{REF\,IN}$ (which corresponds to the basic unipolar range 0 to $V_{REF\,IN}$) results if $R_1 = R_3 = 5.4k$ and $R_2 = \infty$.

Assuming the $V_{REF\,IN}=2.5V$ the nominal values of resistors for $\pm\,5$ and $\pm\,10V$ input ranges are given in the following table.



| Input range | G | R ₁ | R ₂ | R ₃ |
|-------------|---|----------------|----------------|----------------|
| ± 5V | 2 | 10.8k | 10.8k | 5.4k |
| ± 10V | 4 | 21.6k | 7.2k | 5.4k |

Minus full-scale (offset) is set by adjusting $\rm R_1$ about its nominal value relative to $\rm R_3$. Plus full-

scale (gain) is set by adjusting R_2 relative to R_1 . Practical circuit realisations are given in Fig. 23.

BIPOLAR ADJUSTMENT PROCEDURE

(i) Apply continuous WR pulses at intervals long enough to allow a complete conversion or hold WR low and monitor the digital outputs.

OFFSET SETTING

(ii) Apply – (FS - ½LSB) to A_{IN} and adjust offset until the DBO (LSB) output just flickers between 0 and 1 with all other bits at 0. i.e. for transition 00000000 to 00000001.

GAIN SETTING

(iii) Apply + (FS - 1½LSB) to A_{IN} and adjust gain until DBO (LSB) just flickers between 0 and 1 with all other bits at 1.

i.e. for transition 11111111 to 11111110.

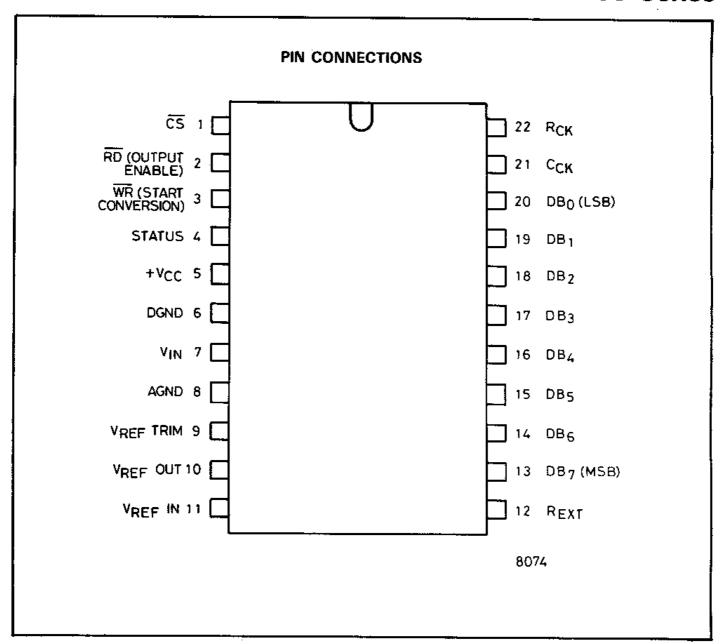
BIPOLAR SETTING-UP POINTS

| Input range, ±FS | -(FS - ½LSB) | + (FS - 1½LSB) |
|------------------|--------------|----------------|
| <u>+</u> 5V | - 4.9805V | +4.9414V |
| ± 10V | -9.9609V | + 9.8828V |

$$1LSB = \frac{2FS}{256}$$

BIPOLAR LOGIC CODING

| Analogue input (A _{IN}) | Digital output code | | |
|--|--|--|--|
| (Nominal code centre value) | MSB LSB | | |
| + (FS - 1LSB) + (FS - 2LSB) + ½FS + 1LSB 0 - 1LSB - ½FS - (FS - 1LSB) - FS | 1111111 11111110 11000000 10000001 1000000 | | |



ORDERING INFORMATION

| Туре | Linearity error (LSB) | Operating temperature range | Package |
|----------|-----------------------|-----------------------------|---------|
| ZN439E-9 | 1/4 | 0°C to +70°C | Moulded |
| ZN439J-9 | 1/4 | -55°C to +125°C | Ceramic |
| ZN439E-8 | 1/2 | 0°C to +70°C | Moulded |
| ZN439J-8 | 1/2 | -55°C to +125°C | Ceramic |
| ZN439E-7 | 1 | 0°C to +70°C | Moulded |
| ZN439J-7 | 1 | -55°C to +125°C | Ceramic |